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Understanding Embedded - FPGAs (Field Programmable Gate Array)

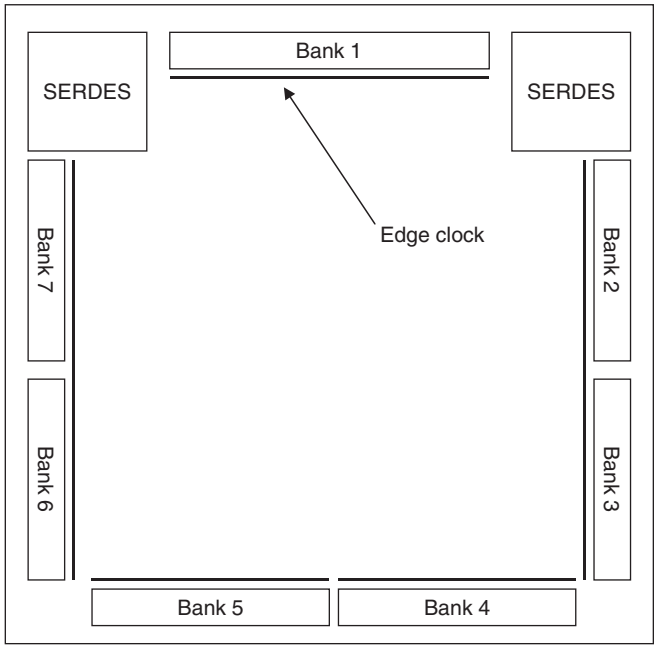
Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details	
Product Status	Obsolete
Number of LABs/CLBs	6250
Number of Logic Elements/Cells	25000
Total RAM Bits	1966080
Number of I/O	476
Number of Gates	-
Voltage - Supply	0.95V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	1020-BBGA, FCBGA
Supplier Device Package	1020-OFcBGA Rev 2 (33x33)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfsc3ga25e-5ffan1020c

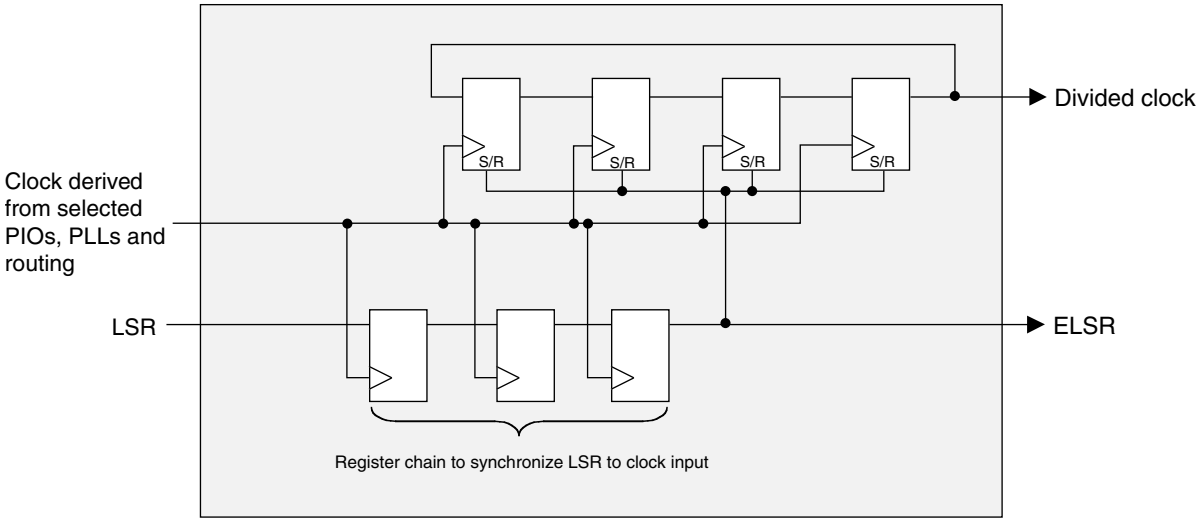
Figure 2-7. Edge Clock Resources



Precision Clock Divider

Each set of edge clocks has four high-speed dividers associated with it. These are intended for generating a slower speed system clock from the high-speed edge clock. The block operates in a DIV2 or DIV4 mode and maintains a known phase relationship between the divided down clock and high-speed clock based on the release of its reset signal. The clock dividers can be fed from selected PIOs, PLLs and routing. The clock divider outputs serve as primary clock sources. This circuit also generates an edge local set/reset (ELSR) signal which is fed to the PIOs via the edge clock network and is used for the rest of the I/O gearing logic.

Figure 2-8. Clock Divider Circuit



Dynamic Clock Select (DCS)

The DCS is a global clock buffer with smart multiplexer functions. It takes two independent input clock sources and outputs a clock signal without any glitches or runt pulses. This is achieved irrespective of where the select signal is

toggled. There are eight DCS blocks per device, located in pairs at the center of each side. Figure 2-9 illustrates the DCS Block diagram.

Figure 2-9. DCS Block Diagram

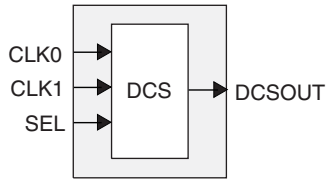
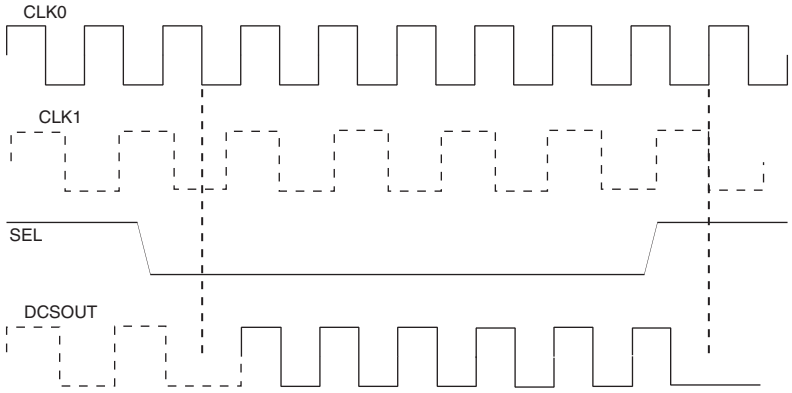


Figure 2-10 shows timing waveforms for one of the DCS operating modes. The DCS block can be programmed to other modes. For more information on the DCS, please see details of additional technical documentation at the end of this data sheet.

Figure 2-10. DCS Waveforms



Clock Boosting

There are programmable delays available in the clock signal paths in the PFU, PIC and EBR blocks. These allow setup and clock-to-output times to be traded to meet critical timing without slowing the system clock. If this feature is enabled then the design tool automatically uses these delays to improve timing performance.

Global Set/Reset

There is a global set/reset (GSR) network on the device that is distributed to all FFs, PLLs, DLLs and other blocks on the device. This GSR network can operate in two modes:

a) asynchronous - no clock is required to get into or out of the reset state.

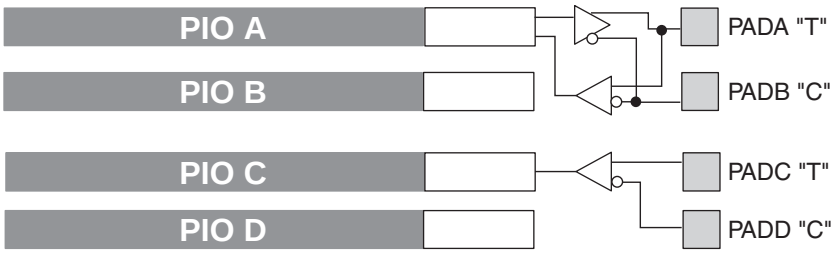
b) synchronous - The global GSR net is synchronized to a user selected clock. In this mode it continues to be asynchronous to get into the reset state, but is synchronous to get out of the reset state. This allows all registers on the device to become operational in the same clock period. The synchronous GSR goes out of reset in two cycles from the clock edge where the setup time of the FF was met (not from the GSR being released).

sysCLOCK Phase Locked Loops (PLLs)

The sysCLOCK PLLs provide the ability to synthesize clock frequencies. Each PLL has four dividers associated with it: input clock divider, feedback divider and two clock output dividers. The input divider is used to divide the input clock signal, while the feedback divider is used to multiply the input clock signal.

high-speed interfaces in the LatticeSC devices. Figure 2-18 shows how differential receivers and drivers are arranged between PIOs.

Figure 2-18. Differential Drivers and Receivers



*Differential Driver only available on right and left of the device.

PIO

The PIO contains five blocks: an input register block, output register block, tristate register block, update block, and a control logic block. These blocks contain registers for both single data rate (SDR), double data rate (DDR), and shift register operation along with the necessary clock and selection logic.

Input Register Block

The input register block contains delay elements and registers that can be used to condition signals before they are passed to the device core. Figure 2-20 show the diagram of the input register block. The signal from the PURESPEED I/O buffer (DI) enters the input register block and can be used for three purposes, as a source for the combinatorial (INDD) and clock outputs (INCK), the input into the SDR register/latch block and the input to the delay block. The output of the delay block can be used as combinatorial (INDD) and clock (INCK) outputs, an input to the DDR/Shift Register Block or an input into the SDR register block.

Input SDR Register/Latch Block

The SDR register/latch block has a latch and a register/latch that can be used in a variety of combinations to provide a registered or latched output (INFF). The latch operates off high-speed input clocks and latches data on the positive going edge. The register/latch operates off the low-speed input clock and registers/latches data on the positive going edge. Both the latch and the register/latch have a clock enable input that is driven by the input clock enable. In addition both have a variety of programmable options for set/reset including, set or reset, asynchronous or synchronous Local Set Reset LSR (LSR has precedence over CE) and Global Set Reset GSR enable or disable. The register and latch LSR inputs are driven from LSRI, which is generated from the PIO control MUX. The GSR inputs are driven from the GSR output of the PIO control MUX, which allows the global set-reset to be disabled on a PIO basis.

Input Delay Block

The delay block uses 144 tapped delay lines to obtain coarse and fine delay resolution. These delays can be adjusted during configuration or automatically via DLL or AIL blocks. The Adaptive Input Logic (AIL) uses this delay block to adjust automatically the delay in the data path to ensure that it has sufficient setup and hold time.

The delay line in this block matches the delay line that is used in the 12 on-chip DLLs. The delay line can be set via configuration bits or driven from a calibration bus that allows the setting to be controlled either from one of the on-chip DLLs or user logic. Controlling the delay from one of the on-chip DLLs allow the delay to be calibrated to the DLL clock and hence compensated for the variations in process, voltage and temperature.

this allows for easy integration with the rest of the system. These capabilities make the LatticeSC ideal for many multiple power supply and hot-swap applications. The maximum current during hot socketing is 4mA. See Hot Socketing Specifications in Chapter 3 of this data sheet.

Power-Up Requirements

To prevent high power supply and input pin currents, each VCC, VCC12, VCCAUX, VCCIO and VCCJ power supplies must have a monotonic ramp up time of 75 ms or less to reach its minimum operating voltage. Apart from VCC and VCC12, which have an additional requirement, and VCCIO and VCCAUX, which also have an additional requirement, the VCC, VCC12, VCCAUX, VCCIO and VCCJ power supplies can ramp up in any order, with no restriction on the time between them. However, the ramp time for each must be 75 ms or less. Configuration of the device will not proceed until the last power supply has reached its minimum operating voltage.

Additional Requirement for VCC and VCC12:
VCC12 must always be higher than VCC. This condition must be maintained at ALL times, including during power-up and power-down. Note that for 1.2V only operation, it is advisable to source both of these supplies from the same power supply.

Additional Requirement for VCCIO and VCCAUX:
If any VCCIOs are 1.2/1.5/1.8V, then VCCAUX MUST be applied before them. If any VCCIO is 1.2/1.5/1.8V and is powered up before VCCAUX, then when VCCAUX is powered up, it may drag VCCIO up with it as it crosses through the VCCIO value. (Note: If the VCCIO supply is capable of sinking current, as well as the more usual sourcing capability, this behavior is eliminated. However, the amount of current that the supply needs to sink is unknown and is likely to be in the hundreds of milliamps range).

Power-Down Requirements

To prevent high power supply and input pin currents, power must be removed monotonically from either VCC or VCCAUX (and must reach the power-down trip point of 0.5V for VCC, 0.95V for VCCAUX) before power is removed monotonically from VCC12, any of the VCCIOs, or VCCJ. Note that VCC12 can be removed at the same time as VCC, but it cannot be removed earlier. In many applications, VCC and VCC12 will be sourced from the same power supply and so will be removed together. For systems where disturbance of the user pins is a don't care condition, the power supplies can be removed in any order as long as they power down monotonically within 200ms of each other.

Additionally, if any banks have VCCIO=3.3V nominal (potentially banks 1, 4, 5) then VCCIO for those banks must not be lower than VCCAUX during power-down. The normal variation in ramp-up times of power supplies and voltage regulators is not a concern here.

Note: The SERDES power supplies are NOT included in these requirements and have no specific sequencing requirements. However, when using the SERDES with VDDIB or VDDOB that is greater than 1.2V (1.5V nominal for example), the SERDES should not be left in a steady state condition with the 1.5V power applied and the 1.2V power not applied. Both the 1.2V and 1.5V power should be applied to the SERDES at nominally the same time. The normal variation in the ramp-up times of power supplies and voltage regulators is not a concern here.

SERDES Power Supply Sequencing Requirements

When using the SERDES with 1.5V VDDIB or VDDOB supplies, the SERDES should not be left in a steady state condition with the 1.5V power applied and the 1.2V power not applied. Both the 1.2V and the 1.5V power should be applied to the SERDES at nominally the same time. The normal variation in ramp-up times of power supples and voltage regulators is not a concern.

Additional Requirement for SERDES Power Supply
All VCC12 pins need to be connected on all devices independent of functionality used on the device. This analog supply is used by both the RX and TX portions of the SERDES and is used to control the core SERDES logic regardless of the SERDES being used in the design. VDDIB and VDDOB are used as supplies for the terminations on the CML input and output buffers. If a particular channel is not used, these can be UNCONNECTED (floating).

flexiPCS quads are not dedicated solely to industry standard protocols. Each quad (and each channel within a quad) can be programmed for many user defined data manipulation modes. For example, modes governing user-defined word alignment and multi-channel alignment can be programmed for non-standard protocol applications.

For more information on the functions and use of the flexiPCS, refer to the LatticeSC/M Family flexiPCS Data Sheet.

System Bus

Each LatticeSC device connects the FPGA elements with a standardized bus framework referred to as a System Bus. Multiple bus masters optimize system performance by sharing resources between different bus masters such as the MPI and configuration logic. The wide data bus configuration of 32 bits with 4-bit parity supports high-bandwidth, data intensive applications.

There are two types of interfaces on the System Bus, master and slave. A master interface has the ability to perform actions on the bus, such as writes and reads to and from a specific address. A slave interface responds to the actions of a master by accepting data and address on a write and providing data on a read. The System Bus has a memory map which describes each of the slave peripherals that is connected on the bus. Using the addresses listed in the memory map, a master interface can access each of the slave peripherals on the System Bus. Any and all peripherals on the System Bus can be used at the same time. Table 2-12 list all of the available user peripherals on the System Bus after device power-up.

Table 2-12. System Bus User Peripherals

Peripheral	Name	Interface Type
Micro Processor Interface	MPI	Master
User Master Interface	UMI	Master
User Slave Interface	USI	Slave
Serial Management Interface (PLL, DLL, User Logic)	SMI	Slave
Physical Coding Sublayer	PCS	Slave
Direct FPGA Access	DFA	Slave

The peripherals listed in Table 2-12 can be added when the System Bus module is created using Module IP/Manager (ispLEVER Module/IP Manager).

Figure 2-31 also lists the existing peripherals on the System Bus. The gray boxes are available only during configuration. Refer to Lattice technical note TN1080, LatticeSC sysCONFIG Usage Guide, for configuration options. The Status and Config box refers to internal System Bus registers. This document presents all the interfaces listed in Table 2-12 in detail to help the user utilize the desired functions of the System Bus.

RSDS

Over Recommended Operating Conditions

Parameter Symbol	Description	Min.	Typ.	Max.	Units
V_{OD}	Output voltage, differential, R_T = 100 ohms	100	200	600	mV
V_{OS}	Output voltage, common mode	0.5	1.2	1.5	V
I_{RSDS}	Differential driver output current	1	2	6	mA
V_{THD}	Input voltage differential	100	—	—	mV
V_{CM}	Input common mode voltage	0.3	—	1.5	V
T_R, T_F	Output rise and fall times, 20% to 80%	—	500	—	ps
T_{ODUTY}	Output clock duty cycle	45	50	55	%

Note: Data is for 2mA drive. Other differential driver current options are available.

BLVDS

The LatticeSC devices support BLVDS standard. This standard is emulated using controlled impedance complementary LVCMOS outputs in conjunction with a parallel external resistor across the driver outputs. BLVDS is intended for use when multi-drop and bi-directional multi-point differential signaling is required. The scheme shown in Figure 3-2 is one possible solution for bi-directional multi-point differential signals.

Figure 3-2. BLVDS Multi-point Output Example

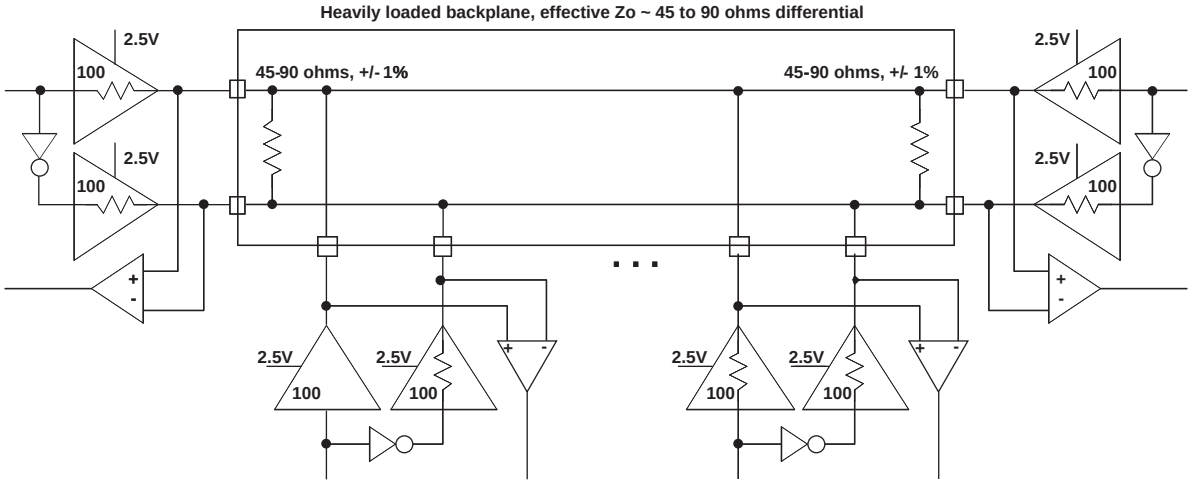


Table 3-2. BLVDS DC Conditions[1]

Over Recommended Operating Conditions

Symbol	Description	Nominal		Units
		Zo = 45	Zo = 90	
Z_{OUT}	Output impedance	100	100	ohm
R_{TLEFT}	Left end termination	45	90	ohm
R_{TRIGHT}	Right end termination	45	90	ohm
V_{OH}	Output high voltage	1.375	1.48	V
V_{OL}	Output low voltage	1.125	1.02	V
V_{OD}	Output differential voltage	0.25	0.46	V
V_{CM}	Output common mode voltage	1.25	1.25	V
I_{DC}	DC output current	11.2	10.2	mA

1. For input buffer, see LVDS table.

LatticeSC/M External Switching Characteristics[3]

Over Recommended Commercial Operating Conditions at VCC = 1.2V +/- 5%

Parameter	Description	-7		-6		-5		Units
		Min.	Max.	Min.	Max.	Min.	Max.	
General I/O Pin Parameters (using Primary Clock without PLL)[2]								
t_{CO}	Global Clock Input to Output - PIO Output Register	2.83	5.74	2.83	6.11	2.83	6.49	ns
t_{SU}	Global Clock Input Setup - PIO Input Register without fixed input delay	-0.66	—	-0.66	—	-0.66	—	ns
t_{H}	Global Clock Input Hold - PIO Input Register without fixed input delay	1.73	—	1.95	—	2.16	—	ns
t_{SU_IDLY}	Global Clock Input Setup - PIO Input Register with input delay	0.86	—	1.03	—	1.20	—	ns
t_{H_IDLY}	Global Clock Input Hold - PIO Input Register with input delay	-0.17	—	-0.17	—	-0.17	—	ns
f_{MAX_PFU}	Global Clock frequency of PFU register	—	700	—	700	—	700	MHz
f_{MAX_IO}	Global Clock frequency of I/O register	—	1000	—	1000	—	1000	MHz
t_{GC_SKEW}	Global Clock skew	—	89	—	103	—	116	ps
General I/O Pin Parameters (using Primary Clock with PLL)[1, 2]								
t_{CO}	Global Clock Input to Output - PIO Output Register	2.25	4.81	2.25	5.08	2.25	5.37	ns
t_{SU}	Global Clock Input Setup - PIO Input Register without fixed input delay	-0.07	—	-0.07	—	-0.07	—	ns
t_{H}	Global Clock Input Hold - PIO Input Register without fixed input delay	0.80	—	0.93	—	1.04	—	ns
General I/O Pin Parameters (using Edge Clock without PLL)[2]								
t_{CO}	Edge Clock Input to Output - PIO Output Register	2.38	4.77	2.38	5.04	2.38	5.33	ns
t_{SU}	Edge Clock Input Setup - PIO Input Register without fixed input delay	-0.08	—	-0.08	—	-0.08	—	ns
t_{H}	Edge Clock Input Hold - PIO Input Register	0.49	—	0.58	—	0.66	—	ns
t_{SU_IDLY}	Edge Clock Input Setup - PIO Input Register with input delay	0.81	—	0.97	—	1.12	—	ns
t_{H_IDLY}	Edge Clock Input Hold - PIO Input Register with input delay	-0.34	—	-0.34	—	-0.34	—	ns
t_{EC_SKEW}	Edge Clock skew	—	28	—	32	—	36	ps
General I/O Pin Parameters (using Latch FF without PLL)[2]								
t_{SU}	Latch FF, Input Setup - PIO Input Register without fixed input delay	-0.14	—	-0.14	—	-0.14	—	ns
t_{H}	Latch FF, Input Hold - PIO Input Register without fixed input delay	0.58	—	0.68	—	0.77	—	ns
t_{SU_IDLY}	Latch FF, Input Setup - PIO Input Register with input delay	0.70	—	0.68	—	0.77	—	ns
t_{H_IDLY}	Latch FF, Input Hold - PIO Input Register with input delay	-0.30	—	-0.30	—	-0.30	—	ns

1. No PLL delay tuning (clock injection removal mode, system clock feedback).
2. Using LVCMOS25 12mA I/O. Timing adders for other supported I/O technologies are specified in the LatticeSC Family Timing Adders table.
3. Complete Timing Parameters for a user design are incorporated when running ispLEVER. This is a sampling of the key timing parameters. Timing specs are for non-AIL applications.

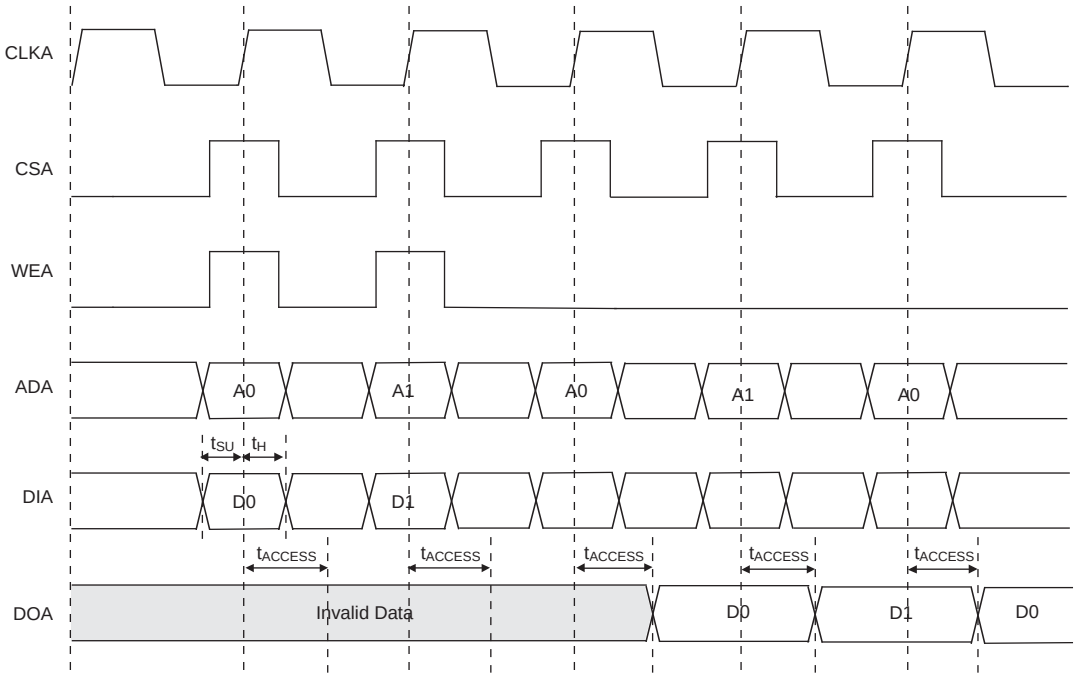
LatticeSC/M Internal Timing Parameters[1]

Over Recommended Commercial Operating Conditions at VCC = 1.2V +/- 5%

Parameter	Symbol	Description	-7		-6		-5		Units
			Min.	Max.	Min.	Max.	Min.	Max.	
PFU Logic Mode Timing									
t_{LUT4_PFU}	CTOF_DEL	LUT4 delay (A to D inputs to F output)	—	0.045	—	0.050	—	0.054	ns
t_{LUT5_PFU}	MTOOFX_DEL	LUT5 delay (inputs to output)	—	0.152	—	0.172	—	0.192	ns
t_{LSR_PFU}	LSR_DEL	Set/Reset to output (asynchronous)	—	0.378	—	0.426	—	0.474	ns
t_{SUM_PFU}	M_SET	Clock to Mux (M0,M1) input setup time	0.113	—	0.131	—	0.148	—	ns
t_{HM_PFU}	M_HLD	Clock to Mux (M0,M1) input hold time	-0.041	—	-0.046	—	-0.052	—	ns
t_{SUD_PFU}	DIN_SET	Clock to D input setup time	0.072	—	0.083	—	0.094	—	ns
t_{HD_PFU}	DIN_HLD	Clock to D input hold time	-0.028	—	-0.032	—	-0.035	—	ns
t_{CK2Q_PFU}	REG_DEL	Clock to Q delay, D-type register configuration	—	0.224	—	0.252	—	0.279	ns
t_{LE2Q_PFU}	LTCH_DEL	Clock to Q delay latch configuration	—	0.294	—	0.331	—	0.367	ns
t_{LD2Q_PFU}	TLTCH_DEL	D to Q throughput delay when latch is enabled	—	0.300	—	0.338	—	0.376	ns
PFU Memory Mode Timing									
t_{CORAM_PFU}	CLKTOF_DEL	Clock to Output	—	0.575	—	0.649	—	0.724	ns
t_{SUDATA_PFU}	DIN_SET	Data Setup Time	-0.024	—	-0.026	—	-0.027	—	ns
t_{HDATA_PFU}	DIN_HLD	Data Hold Time	0.075	—	0.084	—	0.094	—	ns
t_{SUADDR_PFU}	WAD_SET	Address Setup Time	-0.176	—	-0.196	—	-0.215	—	ns
t_{HADDR_PFU}	WAD_HLD	Address Hold Time	0.110	—	0.124	—	0.138	—	ns
t_{SUWREN_PFU}	WE_SET	Write/Read Enable Setup Time	0.014	—	0.019	—	0.024	—	ns
t_{HWREN_PFU}	WE_HLD	Write/Read Enable Hold Time	0.078	—	0.086	—	0.094	—	ns
PIC Timing									
PIO Input/Output Buffer Timing									
t_{IN_PIO}	IN_DEL	Input Buffer Delay(LVCMOS25)	—	0.578	—	0.661	—	0.744	ns
t_{OUT_PIO}	DOPADI_DEL	Output Buffer Delay(LVCMOS25)	—	2.712	—	3.027	—	3.395	ns
t_{SUI_PIO}	DIN_SET	Input Register Setup Time (Data Before Clock)	0.277	—	0.312	—	0.348	—	ns
t_{HI_PIO}	DIN_HLD	Input Register Hold Time (Data after Clock)	-0.267	—	-0.306	—	-0.345	—	ns
t_{COO_PIO}	CK_DEL	Output Register Clock to Output Delay	—	0.513	—	0.571	—	0.639	ns
t_{SUCE_PIO}	CE_SET	Input Register Clock Enable Setup Time	—	0.000	—	0.000	—	0.000	ns
t_{HCE_PIO}	CE_HLD	Input Register Clock Enable Hold Time	—	0.129	—	0.145	—	0.161	ns
t_{SULSR_PIO}	LSR_SET	Set/Reset Setup Time	0.057	—	0.060	—	0.063	—	ns
t_{HLSR_PIO}	LSR_HLD	Set/Reset Hold Time	-0.151	—	-0.159	—	-0.169	—	ns
t_{LE2Q_PIO}	CK_DEL	Input Register Clock to Q delay latch configuration	—	0.335	—	0.372	—	0.410	ns
t_{LD2Q_PIO}	DIN_DEL	Input Register D to Q throughput delay when latch is enabled	—	0.578	—	0.647	—	0.717	ns

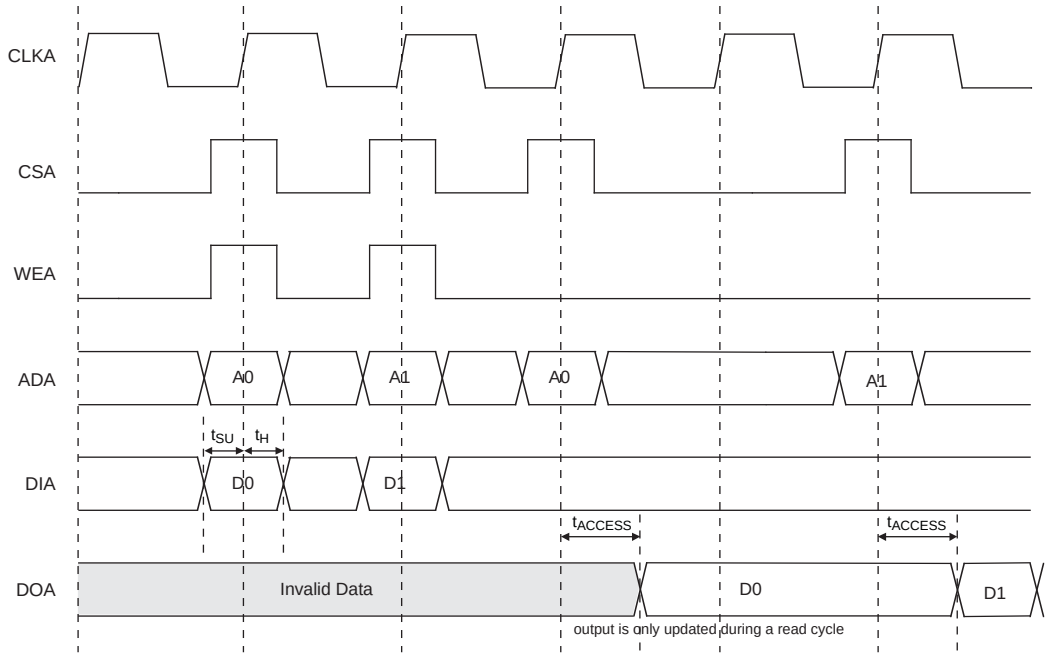
EBR Memory Timing Diagrams

Figure 3-6. Read Mode



Note: Input data and address are registered at the positive edge of the clock and output data appears after the positive of the clock.

Figure 3-7. Read Mode with Input Registers Only



LFSC/M15, LFSC/M25 Logic Signal Connections: 900 fpBGA[1, 2] (Cont.)

Ball Number	LFSC/M15			LFSC/M25		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
R29	PR28B	3		PR31B	3	
P29	PR28A	3		PR31A	3	
P27	PR27C	3	PCLKT3_3	PR30C	3	PCLKT3_3
N29	PR27B	3		PR30B	3	
N28	PR27A	3		PR30A	3	
R25	PR26D	3	PCLKC3_1	PR29D	3	PCLKC3_1
R26	PR26C	3	PCLKT3_1	PR29C	3	PCLKT3_1
R28	PR26B	3	PCLKC3_0	PR29B	3	PCLKC3_0
P28	PR26A	3	PCLKT3_0	PR29A	3	PCLKT3_0
N27	PR24D	2	PCLKC2_2	PR27D	2	PCLKC2_2
P26	PR24C	2	PCLKT2_2	PR27C	2	PCLKT2_2
L30	PR24B	2	PCLKC2_0	PR27B	2	PCLKC2_0
K30	PR24A	2	PCLKT2_0	PR27A	2	PCLKT2_0
J30	PR23B	2	PCLKC2_1	PR26B	2	PCLKC2_1
H30	PR23A	2	PCLKT2_1	PR26A	2	PCLKT2_1
M26	PR22D	2	DIFFR_2	PR25D	2	DIFFR_2
M25	PR22C	2	VREF1_2	PR25C	2	VREF1_2
G29	PR22B	2		PR25B	2	
F29	PR22A	2		PR25A	2	
H28	PR19D	2		PR22D	2	
J28	PR19C	2		PR22C	2	
E30	PR19B	2		PR22B	2	
E29	PR19A	2		PR22A	2	
L26	PR18D	2	VREF2_2	PR18D	2	VREF2_2
L25	PR18C	2		PR18C	2	
F28	PR18B	2	URC_DLLC_IN_D/URC_DLLC_FB_C	PR18B	2	URC_DLLC_IN_D/URC_DLLC_FB_C
G28	PR18A	2	URC_DLLT_IN_D/URC_DLLT_FB_C	PR18A	2	URC_DLLT_IN_D/URC_DLLT_FB_C
K26	PR17D	2	URC_PLLC_IN_B/URC_PLLC_FB_A	PR17D	2	URC_PLLC_IN_B/URC_PLLC_FB_A
K25	PR17C	2	URC_PLLT_IN_B/URC_PLLT_FB_A	PR17C	2	URC_PLLT_IN_B/URC_PLLT_FB_A
D30	PR17B	2	URC_DLLC_IN_C/URC_DLLC_FB_D	PR17B	2	URC_DLLC_IN_C/URC_DLLC_FB_D
D29	PR17A	2	URC_DLLT_IN_C/URC_DLLT_FB_D	PR17A	2	URC_DLLT_IN_C/URC_DLLT_FB_D
G26	PR15D	2		PR16D	2	
H26	PR15C	2		PR16C	2	
E28	PR15B	2	URC_PLLC_IN_A/URC_PLLC_FB_B	PR16B	2	URC_PLLC_IN_A/URC_PLLC_FB_B
D28	PR15A	2	URC_PLLT_IN_A/URC_PLLT_FB_B	PR16A	2	URC_PLLT_IN_A/URC_PLLT_FB_B
J25	VCCJ	-		VCCJ	-	
H25	TDO	-	TDO	TDO	-	TDO
J26	TMS	-		TMS	-	
G25	TCK	-		TCK	-	
G24	TDI	-		TDI	-	
F26	PROGRAMN	1		PROGRAMN	1	
H24	MPIIRQN	1	CFGIRQN/MPI_IRQ_N	MPIIRQN	1	CFGIRQN/MPI_IRQ_N
F25	CCLK	1		CCLK	1	
D27	VCC12	-		VCC12	-	
E26	VCC12	-		VCC12	-	

LFSC/M25, LFSC/M40 Logic Signal Connections: 1020 fcBGA[1, 2] (Cont.)

Ball Number	LFSC/M25			LFSC/M40		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
P32	PL30A	6		PL39A	6	
P31	PL30B	6		PL39B	6	
R28	PL30C	6	PCLKT6_3	PL39C	6	PCLKT6_3
T28	PL30D	6	PCLKC6_3	PL39D	6	PCLKC6_3
R30	PL31A	6		PL40A	6	
R29	PL31B	6		PL40B	6	
T25	PL31C	6	PCLKT6_2	PL40C	6	PCLKT6_2
T26	PL31D	6	PCLKC6_2	PL40D	6	PCLKC6_2
R31	PL34A	6		PL43A	6	
R32	PL34B	6		PL43B	6	
U23	PL34C	6	VREF1_6	PL43C	6	VREF1_6
U24	PL34D	6		PL43D	6	
T31	PL35A	6		PL44A	6	
T32	PL35B	6		PL44B	6	
T27	PL35C	6		PL44C	6	
U28	PL35D	6		PL44D	6	
U32	PL36A	6		PL45A	6	
U31	PL36B	6		PL45B	6	
U26	PL36C	6		PL45C	6	
U25	PL36D	6		PL45D	6	
V32	PL38A	6		PL47A	6	
V31	PL38B	6		PL47B	6	
V24	PL38C	6		PL47C	6	
V23	PL38D	6		PL47D	6	
V29	PL39A	6		PL48A	6	
V30	PL39B	6		PL48B	6	
U27	PL39C	6		PL48C	6	
V28	PL39D	6		PL48D	6	
W30	PL40A	6		PL49A	6	
W29	PL40B	6		PL49B	6	
V25	PL40C	6		PL49C	6	
W26	PL40D	6		PL49D	6	
W31	PL42A	6		PL51A	6	
Y31	PL42B	6		PL51B	6	
W27	PL42C	6		PL51C	6	
Y27	PL42D	6	DIFFR_6	PL51D	6	DIFFR_6
W28	PL43A	6		PL52A	6	
Y28	PL43B	6		PL52B	6	
Y26	PL43C	6		PL52C	6	
W25	PL43D	6		PL52D	6	
W32	PL44A	6		PL53A	6	
Y32	PL44B	6		PL53B	6	
AB28	PL44C	6		PL53C	6	
AA28	PL44D	6		PL53D	6	
AB32	PL47A	6		PL60A	6	
AA32	PL47B	6		PL60B	6	
AB27	PL47C	6		PL60C	6	
AC27	PL47D	6		PL60D	6	
AD31	PL48A	6		PL61A	6	
AC31	PL48B	6		PL61B	6	

LFSC/M25, LFSC/M40 Logic Signal Connections: 1020 fcBGA[1, 2] (Cont.)

Ball Number	LFSC/M25			LFSC/M40		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
AA21	VCCAUX	-		VCCAUX	-	
AA22	VCCAUX	-		VCCAUX	-	
AB11	VCCAUX	-		VCCAUX	-	
AB12	VCCAUX	-		VCCAUX	-	
AB15	VCCAUX	-		VCCAUX	-	
AB16	VCCAUX	-		VCCAUX	-	
AB17	VCCAUX	-		VCCAUX	-	
AB18	VCCAUX	-		VCCAUX	-	
AB21	VCCAUX	-		VCCAUX	-	
AB22	VCCAUX	-		VCCAUX	-	
L11	VCCAUX	-		VCCAUX	-	
L12	VCCAUX	-		VCCAUX	-	
L14	VCCAUX	-		VCCAUX	-	
L15	VCCAUX	-		VCCAUX	-	
L18	VCCAUX	-		VCCAUX	-	
L19	VCCAUX	-		VCCAUX	-	
L21	VCCAUX	-		VCCAUX	-	
L22	VCCAUX	-		VCCAUX	-	
M11	VCCAUX	-		VCCAUX	-	
M12	VCCAUX	-		VCCAUX	-	
M21	VCCAUX	-		VCCAUX	-	
M22	VCCAUX	-		VCCAUX	-	
P11	VCCAUX	-		VCCAUX	-	
P22	VCCAUX	-		VCCAUX	-	
R11	VCCAUX	-		VCCAUX	-	
R22	VCCAUX	-		VCCAUX	-	
V11	VCCAUX	-		VCCAUX	-	
V22	VCCAUX	-		VCCAUX	-	
W11	VCCAUX	-		VCCAUX	-	
W22	VCCAUX	-		VCCAUX	-	
N11	VTT_2	2		VTT_2	2	
R10	VTT_2	2		VTT_2	2	
T11	VTT_3	3		VTT_3	3	
U11	VTT_3	3		VTT_3	3	
Y11	VTT_3	3		VTT_3	3	
AB13	VTT_4	4		VTT_4	4	
AB14	VTT_4	4		VTT_4	4	
AC15	VTT_4	4		VTT_4	4	
AB19	VTT_5	5		VTT_5	5	
AB20	VTT_5	5		VTT_5	5	
AC18	VTT_5	5		VTT_5	5	
T22	VTT_6	6		VTT_6	6	
U22	VTT_6	6		VTT_6	6	
Y22	VTT_6	6		VTT_6	6	
N22	VTT_7	7		VTT_7	7	
R23	VTT_7	7		VTT_7	7	
M17	VCC12	-		VCC12	-	
M16	VCC12	-		VCC12	-	
T12	VCC12	-		VCC12	-	
T21	VCC12	-		VCC12	-	

LFSC/M40, LFSC/M80 Logic Signal Connections: 1152 fcBGA[1, 2] (Cont.)

Ball Number	LFSC/M40			LFSC/M80		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
F15	PT55A	1	D5/MPI_DATA5	PT74A	1	D5/MPI_DATA5
K14	PT54D	1	D4/MPI_DATA4	PT73D	1	D4/MPI_DATA4
K13	PT54C	1	D3/MPI_DATA3	PT73C	1	D3/MPI_DATA3
B15	PT53B	1	D2/MPI_DATA2	PT73B	1	D2/MPI_DATA2
A15	PT53A	1	D1/MPI_DATA1	PT73A	1	D1/MPI_DATA1
J14	PT51D	1	D16/PCLKC1_3/MPI_DATA16	PT71D	1	D16/PCLKC1_3/MPI_DATA16
H14	PT51C	1	D17/PCLKT1_3/MPI_DATA17	PT71C	1	D17/PCLKT1_3/MPI_DATA17
A16	PT51B	1	D0/MPI_DATA0	PT71B	1	D0/MPI_DATA0
B16	PT51A	1	QOUT/CEON	PT71A	1	QOUT/CEON
J13	PT50D	1	VREF2_1	PT70D	1	VREF2_1
H13	PT50C	1	D18/MPI_DATA18	PT70C	1	D18/MPI_DATA18
D15	PT50B	1	DOUT	PT70B	1	DOUT
E15	PT50A	1	MCA_DONE_IN	PT70A	1	MCA_DONE_IN
J16	PT49D	1	D19/PCLKC1_2/MPI_DATA19	PT69D	1	D19/PCLKC1_2/MPI_DATA19
J17	PT49C	1	D20/PCLKT1_2/MPI_DATA20	PT69C	1	D20/PCLKT1_2/MPI_DATA20
D16	PT49B	1	MCA_CLK_P1_OUT	PT69B	1	MCA_CLK_P1_OUT
E16	PT49A	1	MCA_CLK_P1_IN	PT69A	1	MCA_CLK_P1_IN
H15	PT47D	1	D21/PCLKC1_1/MPI_DATA21	PT67D	1	D21/PCLKC1_1/MPI_DATA21
H16	PT47C	1	D22/PCLKT1_1/MPI_DATA22	PT67C	1	D22/PCLKT1_1/MPI_DATA22
C15	PT47B	1	MCA_CLK_P2_OUT	PT67B	1	MCA_CLK_P2_OUT
C16	PT47A	1	MCA_CLK_P2_IN	PT67A	1	MCA_CLK_P2_IN
L17	PT46D	1	MCA_DONE_OUT	PT66D	1	MCA_DONE_OUT
K17	PT46C	1	BUSYN/RCLK/SCK	PT66C	1	BUSYN/RCLK/SCK
E17	PT46B	1	DP0/MPI_PAR0	PT66B	1	DP0/MPI_PAR0
F17	PT46A	1	MPI_TA	PT66A	1	MPI_TA
G17	PT45D	1	D23/MPI_DATA23	PT65D	1	D23/MPI_DATA23
H17	PT45C	1	DP2/MPI_PAR2	PT65C	1	DP2/MPI_PAR2
A17	PT45B	1	PCLKC1_0	PT65B	1	PCLKC1_0
B17	PT45A	1	PCLKT1_0/MPI_CLK	PT65A	1	PCLKT1_0/MPI_CLK
G18	PT43D	1	DP3/PCLKC1_4/MPI_PAR3	PT63D	1	DP3/PCLKC1_4/MPI_PAR3
H18	PT43C	1	D24/PCLKT1_4/MPI_DATA24	PT63C	1	D24/PCLKT1_4/MPI_DATA24
E18	PT43B	1	MPI_RETRY	PT63B	1	MPI_RETRY
F18	PT43A	1	A0/MPI_ADDR14	PT63A	1	A0/MPI_ADDR14
J18	PT42D	1	A1/MPI_ADDR15	PT61D	1	A1/MPI_ADDR15
J19	PT42C	1	A2/MPI_ADDR16	PT61C	1	A2/MPI_ADDR16
C20	PT42B	1	A3/MPI_ADDR17	PT61B	1	A3/MPI_ADDR17
C19	PT42A	1	A4/MPI_ADDR18	PT61A	1	A4/MPI_ADDR18
K18	PT41D	1	D25/PCLKC1_5/MPI_DATA25	PT60D	1	D25/PCLKC1_5/MPI_DATA25
L18	PT41C	1	D26/PCLKT1_5/MPI_DATA26	PT60C	1	D26/PCLKT1_5/MPI_DATA26
D19	PT41B	1	A5/MPI_ADDR19	PT60B	1	A5/MPI_ADDR19
E19	PT41A	1	A6/MPI_ADDR20	PT60A	1	A6/MPI_ADDR20
H19	PT39D	1	D27/MPI_DATA27	PT59D	1	D27/MPI_DATA27
H20	PT39C	1	VREF1_1	PT59C	1	VREF1_1
A18	PT39B	1	A7/MPI_ADDR21	PT59B	1	A7/MPI_ADDR21
B18	PT39A	1	A8/MPI_ADDR22	PT59A	1	A8/MPI_ADDR22

LFSC/M40, LFSC/M80 Logic Signal Connections: 1152 fcBGA[1, 2] (Cont.)

Ball Number	LFSC/M40			LFSC/M80		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
AL11	GND	-		GND	-	
AL17	GND	-		GND	-	
AL21	GND	-		GND	-	
AL27	GND	-		GND	-	
AL5	GND	-		GND	-	
AM14	GND	-		GND	-	
AM18	GND	-		GND	-	
AM24	GND	-		GND	-	
AM30	GND	-		GND	-	
AM8	GND	-		GND	-	
AN1	GND	-		GND	-	
AN34	GND	-		GND	-	
AP2	GND	-		GND	-	
AP33	GND	-		GND	-	
B1	GND	-		GND	-	
B34	GND	-		GND	-	
C11	GND	-		GND	-	
C12	GND	-		GND	-	
C13	GND	-		GND	-	
C14	GND	-		GND	-	
C17	GND	-		GND	-	
C21	GND	-		GND	-	
C22	GND	-		GND	-	
C23	GND	-		GND	-	
C24	GND	-		GND	-	
C26	GND	-		GND	-	
C27	GND	-		GND	-	
C30	GND	-		GND	-	
C31	GND	-		GND	-	
C4	GND	-		GND	-	
C5	GND	-		GND	-	
C8	GND	-		GND	-	
C9	GND	-		GND	-	
D18	GND	-		GND	-	
E32	GND	-		GND	-	
E4	GND	-		GND	-	
F19	GND	-		GND	-	
G16	GND	-		GND	-	
G29	GND	-		GND	-	
G7	GND	-		GND	-	
H3	GND	-		GND	-	
H31	GND	-		GND	-	
J10	GND	-		GND	-	
J15	GND	-		GND	-	
J26	GND	-		GND	-	

LFSC/M40, LFSC/M80 Logic Signal Connections: 1152 fcBGA[1, 2] (Cont.)

Ball Number	LFSC/M40			LFSC/M80		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
AB15	VCC12	-		VCC12	-	
AB20	VCC12	-		VCC12	-	
N15	VCC12	-		VCC12	-	
N20	VCC12	-		VCC12	-	
R13	VCC12	-		VCC12	-	
R22	VCC12	-		VCC12	-	
Y13	VCC12	-		VCC12	-	
Y22	VCC12	-		VCC12	-	
AA12	VCCAUX	-		VCCAUX	-	
AA23	VCCAUX	-		VCCAUX	-	
AB12	VCCAUX	-		VCCAUX	-	
AB16	VCCAUX	-		VCCAUX	-	
AB17	VCCAUX	-		VCCAUX	-	
AB18	VCCAUX	-		VCCAUX	-	
AB19	VCCAUX	-		VCCAUX	-	
AB23	VCCAUX	-		VCCAUX	-	
AC12	VCCAUX	-		VCCAUX	-	
AC13	VCCAUX	-		VCCAUX	-	
Y19	GND	-		GND	-	
AC14	VCCAUX	-		VCCAUX	-	
AC17	VCCAUX	-		VCCAUX	-	
AC21	VCCAUX	-		VCCAUX	-	
AC22	VCCAUX	-		VCCAUX	-	
AC23	VCCAUX	-		VCCAUX	-	
M13	VCCAUX	-		VCCAUX	-	
M14	VCCAUX	-		VCCAUX	-	
M18	VCCAUX	-		VCCAUX	-	
M21	VCCAUX	-		VCCAUX	-	
M22	VCCAUX	-		VCCAUX	-	
N12	VCCAUX	-		VCCAUX	-	
N16	VCCAUX	-		VCCAUX	-	
N17	VCCAUX	-		VCCAUX	-	
N18	VCCAUX	-		VCCAUX	-	
N19	VCCAUX	-		VCCAUX	-	
N23	VCCAUX	-		VCCAUX	-	
P12	VCCAUX	-		VCCAUX	-	
P23	VCCAUX	-		VCCAUX	-	
T13	VCCAUX	-		VCCAUX	-	
T22	VCCAUX	-		VCCAUX	-	
U12	VCCAUX	-		VCCAUX	-	
U13	VCCAUX	-		VCCAUX	-	
U22	VCCAUX	-		VCCAUX	-	
V13	VCCAUX	-		VCCAUX	-	
V22	VCCAUX	-		VCCAUX	-	
V23	VCCAUX	-		VCCAUX	-	

LFSC/M115 Logic Signal Connections: 1152 fcBGA[1, 2]

Ball Number	LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function
AL5	GND	-	
AM14	GND	-	
AM18	GND	-	
AM24	GND	-	
AM30	GND	-	
AM8	GND	-	
AN1	GND	-	
AN34	GND	-	
AP2	GND	-	
AP33	GND	-	
B1	GND	-	
B34	GND	-	
C11	GND	-	
C12	GND	-	
C13	GND	-	
C14	GND	-	
C17	GND	-	
C21	GND	-	
C22	GND	-	
C23	GND	-	
C24	GND	-	
C26	GND	-	
C27	GND	-	
C30	GND	-	
C31	GND	-	
C4	GND	-	
C5	GND	-	
C8	GND	-	
C9	GND	-	
D18	GND	-	
E32	GND	-	
E4	GND	-	
F19	GND	-	
G16	GND	-	
G29	GND	-	
G7	GND	-	
H3	GND	-	
H31	GND	-	
J10	GND	-	
J15	GND	-	
J26	GND	-	
K20	GND	-	
K23	GND	-	

LFSC/M80, LFSC/M115 Logic Signal Connections: 1704 fcBGA[1, 2] (Cont.)

Ball Number	LFSC/M80			LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
AY41	PB12A	5		PB13A	5	
BA41	PB12B	5		PB13B	5	
AT39	PB12C	5		PB13C	5	
AT38	PB12D	5		PB13D	5	
AV37	PB13A	5		PB15A	5	
AV36	PB13B	5		PB15B	5	
AM31	PB13C	5		PB15C	5	
AM32	PB13D	5		PB15D	5	
BA40	PB15A	5		PB16A	5	
BB40	PB15B	5		PB16B	5	
AM29	PB15C	5		PB16C	5	
AL29	PB15D	5		PB16D	5	
AY39	PB16A	5		PB17A	5	
AY38	PB16B	5		PB17B	5	
AN33	PB16C	5		PB17C	5	
AN32	PB16D	5		PB17D	5	
BA39	PB17A	5		PB19A	5	
BA38	PB17B	5		PB19B	5	
AT37	PB17C	5		PB19C	5	
AT36	PB17D	5		PB19D	5	
AW36	PB19A	5		PB20A	5	
AW35	PB19B	5		PB20B	5	
AM28	PB19C	5		PB20C	5	
AL28	PB19D	5		PB20D	5	
BB38	PB20A	5		PB21A	5	
BB39	PB20B	5		PB21B	5	
AR34	PB20C	5		PB21C	5	
AR33	PB20D	5		PB21D	5	
AV35	PB21A	5		PB23A	5	
AV34	PB21B	5		PB23B	5	
AT33	PB21C	5		PB23C	5	
AT34	PB21D	5		PB23D	5	
BA37	PB23A	5		PB25A	5	
BA36	PB23B	5		PB25B	5	
AP33	PB23C	5		PB25C	5	
AP32	PB23D	5		PB25D	5	
AY36	PB24A	5		PB26A	5	
AY35	PB24B	5		PB26B	5	
AN31	PB24C	5		PB26C	5	
AN30	PB24D	5		PB26D	5	
BB37	PB25A	5		PB27A	5	
BB36	PB25B	5		PB27B	5	
AP31	PB25C	5		PB27C	5	
AP30	PB25D	5		PB27D	5	
AV33	PB27A	5		PB29A	5	

LFSC/M80, LFSC/M115 Logic Signal Connections: 1704 fcBGA[1, 2] (Cont.)

Ball Number	LFSC/M80			LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
AP26	PB41C	5		PB43C	5	
AN26	PB41D	5		PB43D	5	
AY30	PB43A	5		PB45A	5	
AY29	PB43B	5		PB45B	5	
AU30	PB43C	5		PB45C	5	
AU31	PB43D	5		PB45D	5	
AV27	PB44A	5		PB46A	5	
AV26	PB44B	5		PB46B	5	
AT28	PB44C	5		PB46C	5	
AT27	PB44D	5		PB46D	5	
BA29	PB45A	5		PB47A	5	
BA28	PB45B	5		PB47B	5	
AL25	PB45C	5		PB47C	5	
AM25	PB45D	5		PB47D	5	
BB29	PB47A	5		PB49A	5	
BB28	PB47B	5		PB49B	5	
AN25	PB47C	5		PB49C	5	
AP25	PB47D	5		PB49D	5	
AY27	PB48A	5	PCLKT5_3	PB50A	5	PCLKT5_3
AY26	PB48B	5	PCLKC5_3	PB50B	5	PCLKC5_3
AT25	PB48C	5	PCLKT5_4	PB50C	5	PCLKT5_4
AT24	PB48D	5	PCLKC5_4	PB50D	5	PCLKC5_4
AW27	PB49A	5	PCLKT5_5	PB51A	5	PCLKT5_5
AW26	PB49B	5	PCLKC5_5	PB51B	5	PCLKC5_5
AU29	PB49C	5		PB51C	5	
AU28	PB49D	5		PB51D	5	
BB27	PB51A	5	PCLKT5_0	PB53A	5	PCLKT5_0
BB26	PB51B	5	PCLKC5_0	PB53B	5	PCLKC5_0
AR25	PB51C	5		PB53C	5	
AR24	PB51D	5	VREF2_5	PB53D	5	VREF2_5
BA27	PB52A	5	PCLKT5_1	PB54A	5	PCLKT5_1
BA26	PB52B	5	PCLKC5_1	PB54B	5	PCLKC5_1
AP24	PB52C	5	PCLKT5_6	PB54C	5	PCLKT5_6
AN24	PB52D	5	PCLKC5_6	PB54D	5	PCLKC5_6
AV25	PB53A	5	PCLKT5_2	PB55A	5	PCLKT5_2
AV24	PB53B	5	PCLKC5_2	PB55B	5	PCLKC5_2
AU27	PB53C	5	PCLKT5_7	PB55C	5	PCLKT5_7
AU26	PB53D	5	PCLKC5_7	PB55D	5	PCLKC5_7
BA25	PB55A	5		PB57A	5	
BA24	PB55B	5		PB57B	5	
AU24	PB55C	5		PB57C	5	
AU25	PB55D	5		PB57D	5	
BB24	PB56A	5		PB58A	5	
BB25	PB56B	5		PB58B	5	
AM23	PB56C	5		PB58C	5	

Commercial, Cont.

Part Number	Grade	Package	Balls	Temp.	LUTs (K)
LFSC3GA40E-7FFN1020C[1]	-7	Lead-Free Organic fcBGA	1020	COM	40.4
LFSC3GA40E-6FFN1020C[1]	-6	Lead-Free Organic fcBGA	1020	COM	40.4
LFSC3GA40E-5FFN1020C[1]	-5	Lead-Free Organic fcBGA	1020	COM	40.4
LFSC3GA40E-7FFAN1020C	-7	Lead-Free Organic fcBGA Revision 2	1020	COM	40.4
LFSC3GA40E-6FFAN1020C	-6	Lead-Free Organic fcBGA Revision 2	1020	COM	40.4
LFSC3GA40E-5FFAN1020C	-5	Lead-Free Organic fcBGA Revision 2	1020	COM	40.4
LFSC3GA40E-7FCN1152C[2]	-7	Lead-Free Ceramic fcBGA	1152	COM	40.4
LFSC3GA40E-6FCN1152C[2]	-6	Lead-Free Ceramic fcBGA	1152	COM	40.4
LFSC3GA40E-5FCN1152C[2]	-5	Lead-Free Ceramic fcBGA	1152	COM	40.4
LFSC3GA40E-7FFN1152C	-7	Lead-Free Organic fcBGA	1152	COM	40.4
LFSC3GA40E-6FFN1152C	-6	Lead-Free Organic fcBGA	1152	COM	40.4
LFSC3GA40E-5FFN1152C	-5	Lead-Free Organic fcBGA	1152	COM	40.4

1. Converted to organic flip-chip BGA package revision 2 per PCN #02A-10.
2. Converted to organic flip-chip BGA package per PCN #01A-10.

Part Number	Grade	Package	Balls	Temp.	LUTs (K)
LFSCM3GA40EP1-7FFN1020C[1]	-7	Organic fcBGA	1020	COM	40.4
LFSCM3GA40EP1-6FFN1020C[1]	-6	Organic fcBGA	1020	COM	40.4
LFSCM3GA40EP1-5FFN1020C[1]	-5	Organic fcBGA	1020	COM	40.4
LFSCM3GA40EP1-7FFAN1020C	-7	Organic fcBGA Revision 2	1020	COM	40.4
LFSCM3GA40EP1-6FFAN1020C	-6	Organic fcBGA Revision 2	1020	COM	40.4
LFSCM3GA40EP1-5FFAN1020C	-5	Organic fcBGA Revision 2	1020	COM	40.4
LFSCM3GA40EP1-7FCN1152C[2]	-7	Ceramic fcBGA	1152	COM	40.4
LFSCM3GA40EP1-6FCN1152C[2]	-6	Ceramic fcBGA	1152	COM	40.4
LFSCM3GA40EP1-5FCN1152C[2]	-5	Ceramic fcBGA	1152	COM	40.4
LFSCM3GA40EP1-7FFN1152C	-7	Organic fcBGA	1152	COM	40.4
LFSCM3GA40EP1-6FFN1152C	-6	Organic fcBGA	1152	COM	40.4
LFSCM3GA40EP1-5FFN1152C	-5	Organic fcBGA	1152	COM	40.4

1. Converted to organic flip-chip BGA package revision 2 per PCN #02A-10.
2. Converted to organic flip-chip BGA package per PCN #01A-10.